



| Parameter | Symbol | Rating | Unit |
|-----------|--------|--------|------|
|-----------|--------|--------|------|

# BRCS4266SCQ

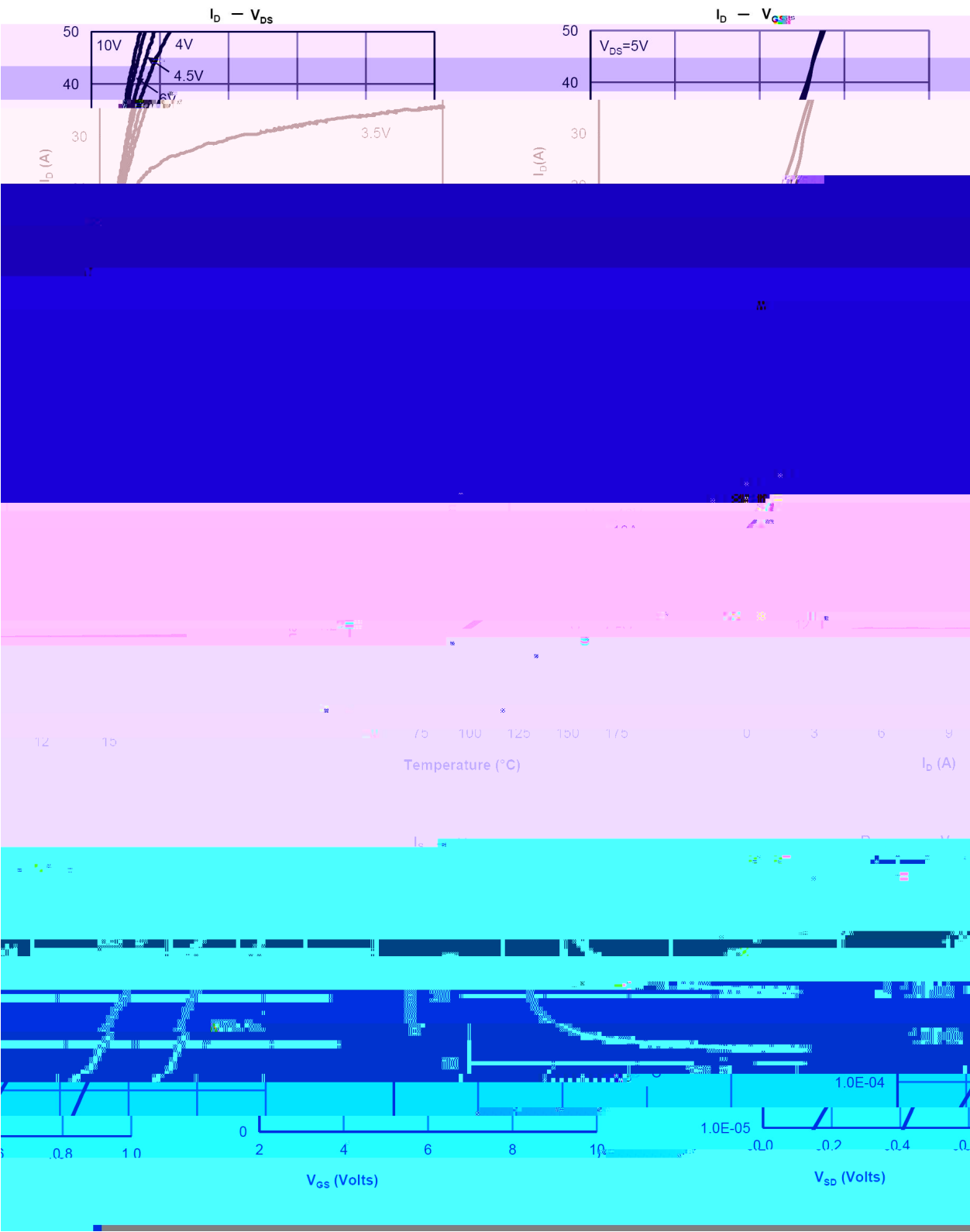
Rev.A Mar.-2023



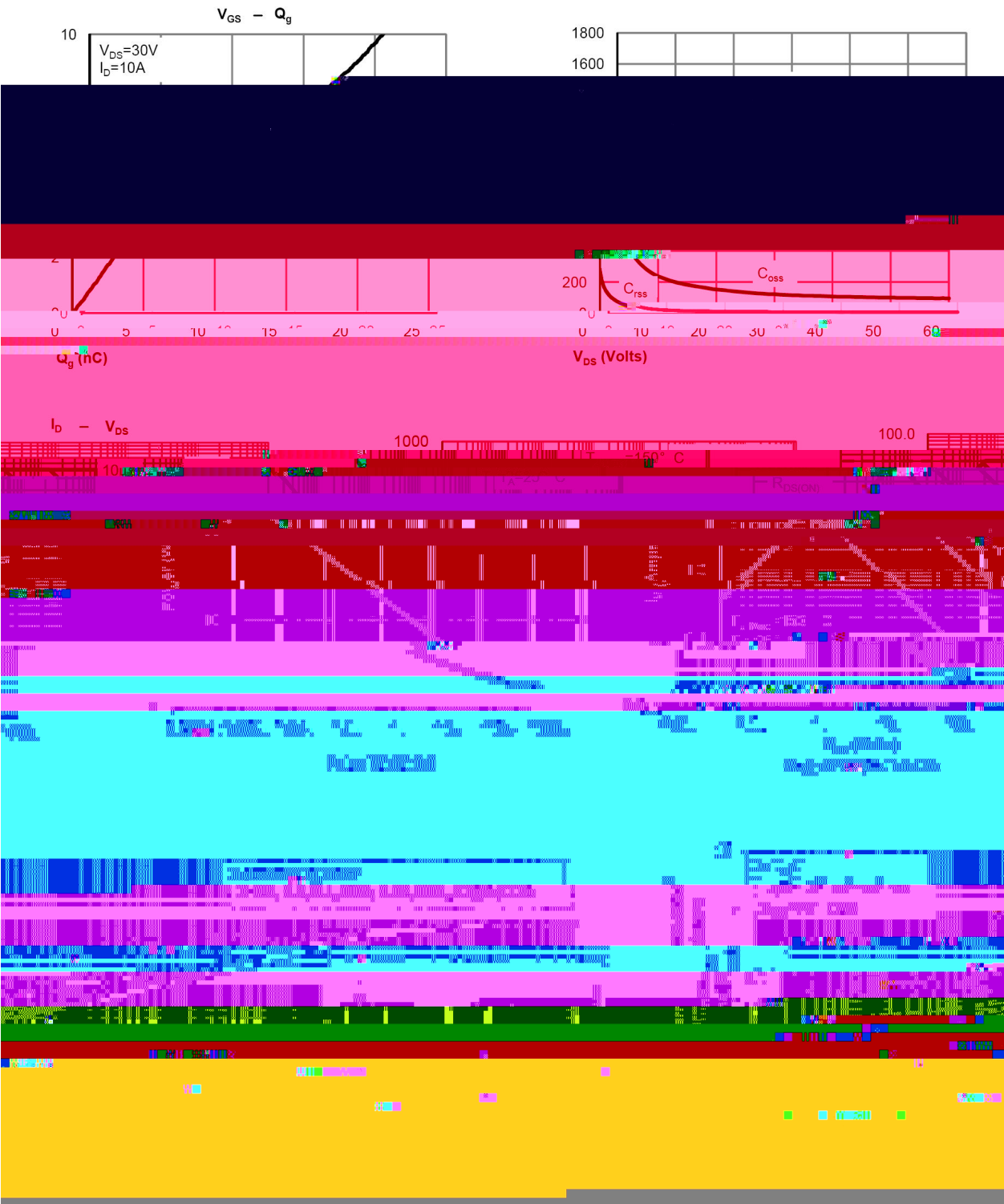
**蓝箭电子**  
BLUE ROCKET ELECTRONICS

DATA SHEET

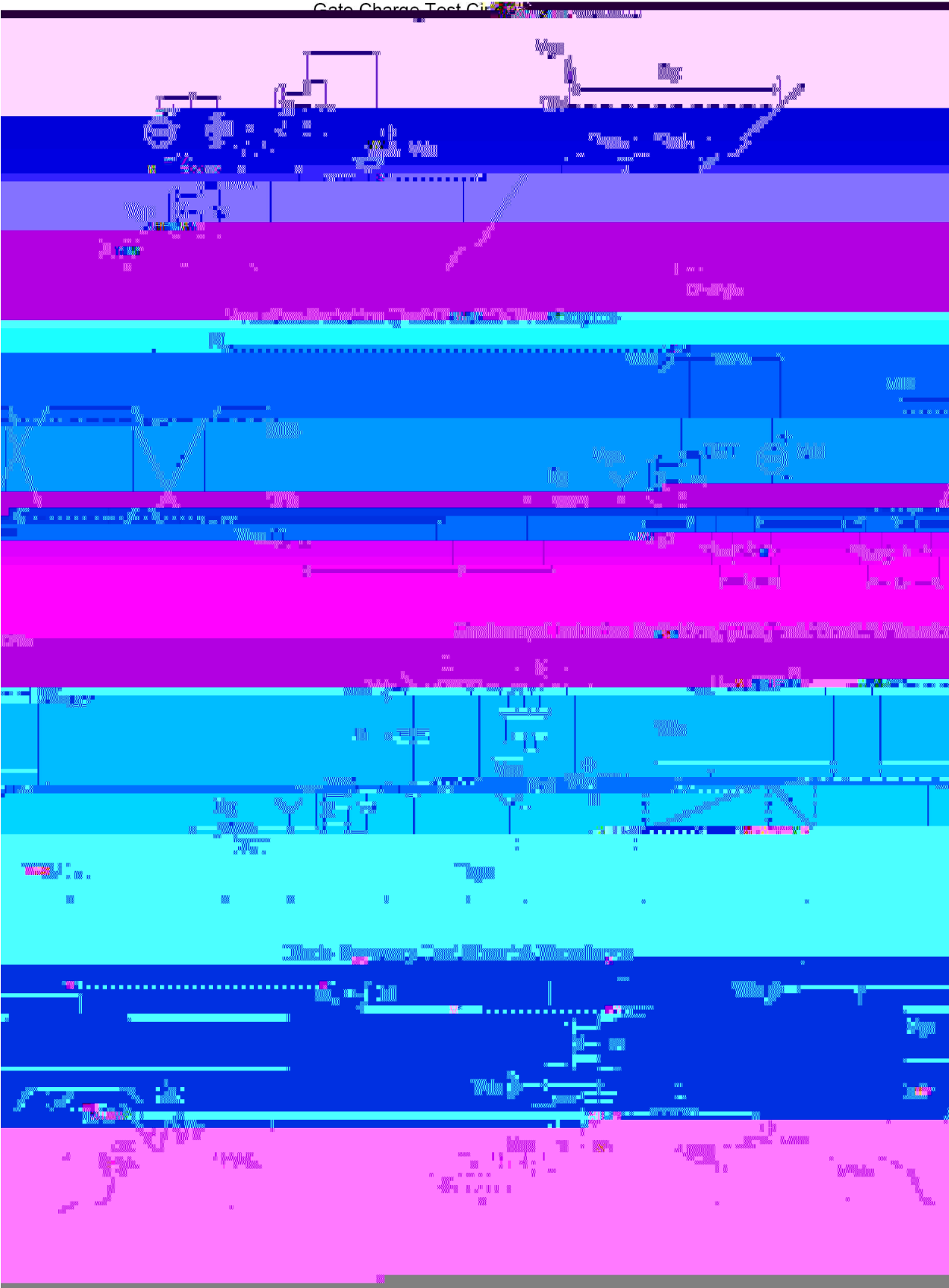
I Electrical Characteristic Curve



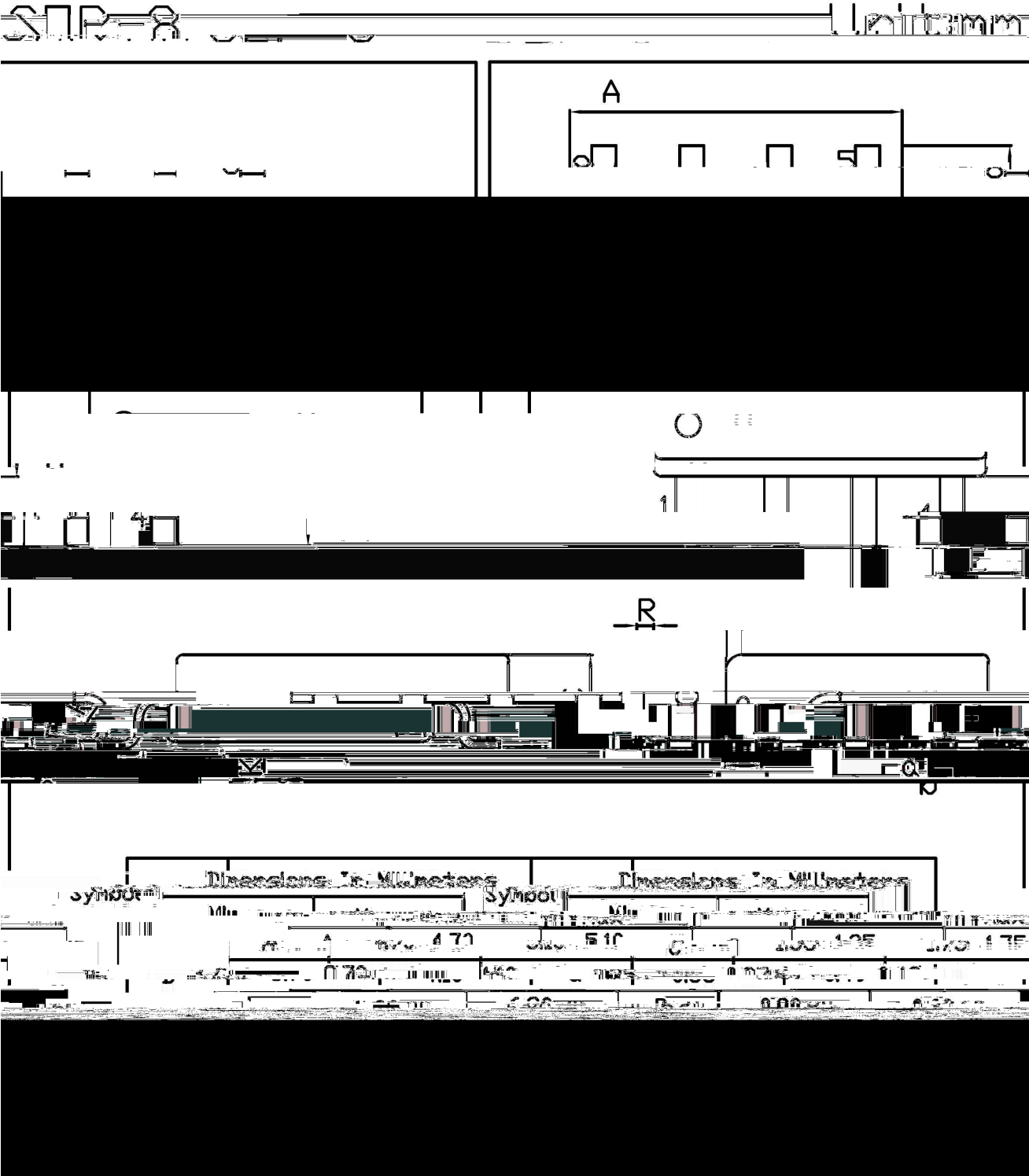
/ Electrical Characteristic Curve



/ Test Circuit & Waveform

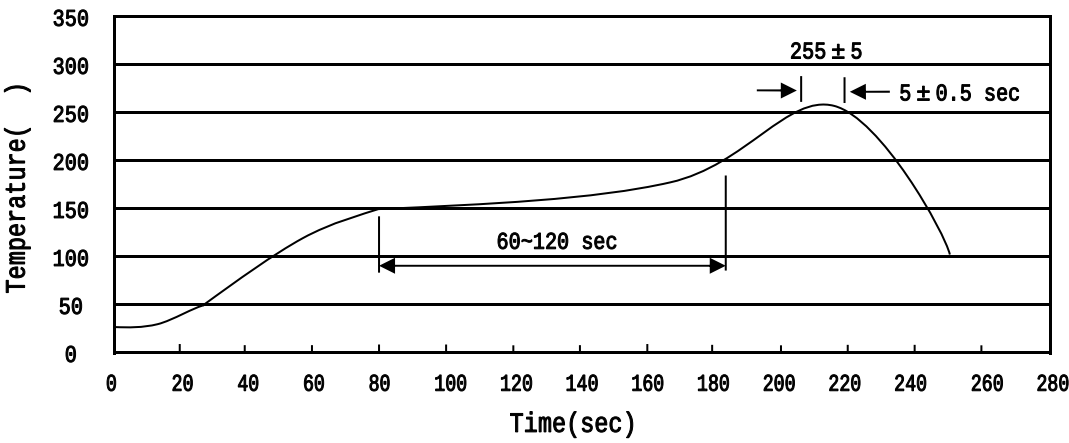


/ Package Dimensions





( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



- 注意
- Note:
1. 150~200℃，时间：60~120sec;

2. 峰值温度：255±5℃，持续时间：5±0.5sec;

3. 冷却速度：2~10℃/sec.

1.Preheating:150~200℃，Time:60~120sec.

2.Peak Temp.:255±5℃，Duration:5±0.5sec.

3. Cooling Speed: 2~10℃/sec.

/ Resistance to Soldering Heat Test Conditions

温度：260±5℃      时间：10±1 sec.      Temp.:260±5℃      Time:10±1 sec

/ Packaging SPEC.

包装形式 / REEL

| Package Type | Units      |                 |                 |                       |                 | Dimension (unit mm <sup>3</sup> ) |            |             |
|--------------|------------|-----------------|-----------------|-----------------------|-----------------|-----------------------------------|------------|-------------|
|              | Units/Reel | Reels/Inner Box | Units/Inner Box | Inner Boxes/Outer Box | Units/Outer Box | Reel                              | Inner Box  | Outer Box   |
| SOP/ESOP-8   | 4,000      | 2               | 8,000           | 6                     | 48,000          | 13 ×12                            | 360×360×50 | 380×335×366 |

/ Notices